

IGBT – Power, Co-PAK N-Channel, Field Stop VII (FS7), SCR, TO247-4L 1200 V, 1.67 V, 40 A

AFGH4L40T120RWD-STD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 4-lead package, this device offers good performance with low on state voltage and low switching losses for both hard and soft switching topologies in automotive applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature T_J =175°C
- Short Circuit Rated and Low Saturation Voltage
- Fast Switching and Tightened Parameter Distribution
- AEC-Q101 Qualified, PPAP Available Upon Request
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

• Automotive E-compressor / Automotive EV PTC Heater / OBC

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Param | Symbol | Value | Unit | | |
|--|---|-----------------|------|---|--|
| Collector-to-Emitter Volta | V_{CE} | 1200 | V | | |
| Gate-to-Emitter Voltage | | V_{GE} | ±20 | | |
| Transient Gate-to-Emitte | er Voltage | 1 | ±30 | | |
| Collector Current | T _C = 25°C | I _C | 80 | Α | |
| | T _C = 100°C | 1 | 40 | | |
| Power Dissipation | T _C = 25°C | P_{D} | 416 | W | |
| | T _C = 100°C | 1 | 208 | | |
| Pulsed Collector Current | T _C = 25°C, tp = 10 μs (Note 1) | I _{CM} | 120 | Α | |
| Diode Forward | T _C = 25°C | I _F | 80 | | |
| Current | T _C = 100°C | 1 | 40 | | |
| Pulsed Diode Maximum $T_C = 25^{\circ}C$, $T_C = 10 \mu s$ (Note 1) | | I _{FM} | 120 | | |
| Short Circuit Withstand Ti V _{GE} = 15 V, V _{CC} = 800 V, | T _{SC} | 6 | μS | | |
| Operating Junction and S Range | T _J , T _{stg} | -55 to +175 | °C | | |
| Lead Temperature for Sol | T _L | 260 | | | |

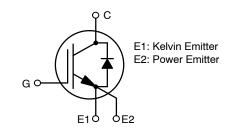
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

1. Repetitive rating: Pulse width limited by max. junction temperature

| BV _{CES} | V _{CE(sat)} TYP | I _C MAX | |
|-------------------|--------------------------|--------------------|--|
| 1200 V | 1.67 V | 40 A | |

PIN CONNECTIONS





TO-247-4LD CASE 340CJ

MARKING DIAGRAM



\$Y = **onsemi** Logo

&Z = Assembly Plant Code &3 = 3-Digit Date Code

&K = 2-Digit Lot Traceability Code

AFGH4L40120RWDSTD = Specific Device code

ORDERING INFORMATION

| Device | Package | Shipping |
|---------------------|------------------------|--------------------|
| AFGH4L40T120RWD-STD | TO-247-4L (Pb-Free) | 30 Units / Tube |

THERMAL CHARACTERISTICS

| Parameter | Symbol | Value | Unit |
|--|------------------|-------|------|
| Thermal Resistance, Junction-to-Case for IGBT | $R_{\theta JC}$ | 0.36 | °C/W |
| Thermal Resistance, Junction-to-Case for Diode | $R_{\theta JCD}$ | 0.66 | |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 40 | |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit |
|---|--------------------------------|---|------|------|------|-------|
| OFF CHARACTERISTICS | | | | | | |
| Collector-to-Emitter Breakdown Voltage | BV _{CES} | $V_{GE} = 0 \text{ V}, I_{C} = 1 \text{ mA}$ | 1200 | - | - | V |
| Collector-to-Emitter Breakdown Voltage Temperature Coefficient | $\Delta BV_{CES}/\Delta T_{J}$ | $V_{GE} = 0 \text{ V}, I_C = 9.99 \text{ mA}$ | - | 1226 | _ | mV/°C |
| Zero Gate Voltage Collector Current | I _{CES} | V _{GE} = 0 V, V _{CE} = V _{CES} | - | - | 40 | μΑ |
| Gate-to-Emitter Leakage Current | I _{GES} | $V_{GE} = \pm 20 \text{ V}, V_{CE} = 0 \text{ V}$ | - | - | ±400 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | V _{GE(th)} | $V_{GE} = V_{CE}$, $I_C = 40 \text{ mA}$ | 5.10 | 6 | 6.90 | V |
| Collector-to-Emitter Saturation | V _{CE(sat)} | V_{GE} = 15 V, I_{C} = 40 A, T_{J} = 25°C | - | 1.67 | 2.00 | V |
| Voltage | | V _{GE} = 15 V, I _C = 40 A, T _J = 175°C | - | 2.12 | _ | |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C _{IES} | V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz | - | 3054 | _ | pF |
| Output Capacitance | C _{OES} | | - | 126 | - | |
| Reverse Transfer Capacitance | C _{RES} | | - | 15.4 | - | |
| Total Gate Charge | Q_{G} | V _{CE} = 600 V, V _{GE} = 15 V, I _C = 40 A | - | 112 | - | nC |
| Gate-to-Emitter Charge | Q_{GE} | | - | 29.6 | - | - |
| Gate-to-Collector Charge | Q_{GC} | | - | 51.1 | - | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | t _{d(on)} | V_{CE} = 600 V, V_{GE} = 15 V, I_{C} = 20 A, R_{G} = 6 Ω , | _ | 37.2 | - | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_{C} = 20 \text{ A}, H_{G} = 6 \Omega,$ $T_{J} = 25^{\circ}\text{C}$ | - | 200 | - | |
| Rise Time | t _r | | - | 15 | - | |
| Fall Time | t _f | | - | 146 | - | |
| Turn-On Switching Loss | E _{on} | | - | 0.54 | - | mJ |
| Turn-Off Switching Loss | E _{off} | | - | 0.99 | - | 1 |
| Total Switching Loss | E _{ts} | | - | 1.54 | - | |
| Turn-On Delay Time | t _{d(on)} | V _{CE} = 600 V, V _{GE} = 15 V, | - | 40.2 | - | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_{C} = 40 \text{ A}, R_{G} = 6 \Omega,$ $T_{J} = 25^{\circ}\text{C}$ | - | 164 | - | |
| Rise Time | t _r | • | _ | 21.9 | _ | 1 |
| Fall Time | t _f | | _ | 90.1 | _ | 1 |
| Turn-On Switching Loss | E _{on} | | _ | 1.56 | - | mJ |
| Turn-Off Switching Loss | E _{off} | | _ | 1.22 | - | 1 |
| Total Switching Loss | E _{ts} | | _ | 2.79 | _ | 1 |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit |
|-------------------------------|---------------------|--|-----|------|------|------|
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | t _{d(on)} | $V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$ | - | 41.4 | - | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_C = 20 \text{ A}, R_G = 6 \Omega,$ $T_A = 175^{\circ}\text{C}$ | - | 270 | - | |
| Rise Time | t _r | | - | 25.5 | - | |
| Fall Time | t _f | | - | 284 | - | |
| Turn-On Switching Loss | E _{on} | | - | 1 | - | mJ |
| Turn-Off Switching Loss | E _{off} | | - | 1.81 | - | |
| Total Switching Loss | E _{ts} | | - | 2.81 | - | |
| Turn-On Delay Time | t _{d(on)} | V _{CE} = 600 V, V _{GE} = 15 V, | - | 46.4 | - | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_{C} = 40 \text{ A}, R_{G} = 6 \Omega,$ $T_{J} = 175^{\circ}\text{C}$ | - | 211 | - | |
| Rise Time | t _r | | - | 38 | - | |
| Fall Time | t _f | | - | 168 | - | |
| Turn-On Switching Loss | E _{on} | | - | 3.05 | - | mJ |
| Turn-Off Switching Loss | E _{off} | | - | 2.15 | - | |
| Total Switching Loss | E _{ts} | | - | 5.19 | - | |
| DIODE CHARACTERISTICS | | | | | | |
| Forward Voltage | V _F | I _F = 40 A, T _J = 25°C | - | 1.99 | 2.36 | V |
| | | I _F = 40 A, T _J = 175°C | _ | 2.06 | - | |
| DIODE SWITCHING CHARACTERIS | TICS, INDUCTIVE | LOAD | | | | |
| Reverse Recovery Time | t _{rr} | V _R = 600 V, I _F = 20 A, | _ | 161 | - | ns |
| Reverse Recovery Charge | Q _{rr} | $dI_F/dt = 500 \text{ A/}\mu\text{s}, T_J = 25^{\circ}\text{C}$ | - | 1732 | - | nC |
| Reverse Recovery Energy | E _{rec} | | - | 0.52 | - | mJ |
| Peak Reverse Recovery Current | I _{RRM} | | - | 25.3 | - | Α |
| Reverse Recovery Time | t _{rr} | $V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A},$ | - | 192 | - | ns |
| Reverse Recovery Charge | Q _{rr} | $dI_F/dt = 500 \text{ A/}\mu\text{s}, T_J = 25^{\circ}\text{C}$ | - | 3051 | - | nC |
| Reverse Recovery Energy | E _{rec} | | - | 0.69 | - | mJ |
| Peak Reverse Recovery Current | I _{RRM} | | - | 35.8 | - | Α |
| Reverse Recovery Time | t _{rr} | $V_R = 600 \text{ V}, I_F = 20 \text{ A},$ | _ | 215 | - | ns |
| Reverse Recovery Charge | Q _{rr} | dl _F /dt = 500 A/μs, T _J = 175°C | _ | 2724 | - | nC |
| Reverse Recovery Energy | E _{rec} | | - | 0.97 | - | mJ |
| Peak Reverse Recovery Current | I _{RRM} | | - | 30 | - | Α |
| Reverse Recovery Time | t _{rr} | $V_R = 600 \text{ V}, I_F = 40 \text{ A},$ | - | 256 | - | ns |
| Reverse Recovery Charge | Q _{rr} | $dI_F/dt = 500 \text{ A/}\mu\text{s}, T_J = 175^{\circ}\text{C}$ | _ | 4974 | - | nC |
| Reverse Recovery Energy | E _{rec} | | _ | 1.35 | - | mJ |
| Peak Reverse Recovery Current | I _{RRM} | | _ | 43.2 | _ | Α |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

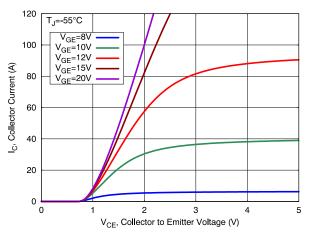


Figure 1. Output Characteristics

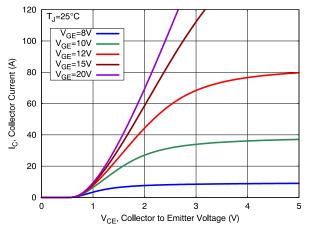


Figure 2. Output Characteristics

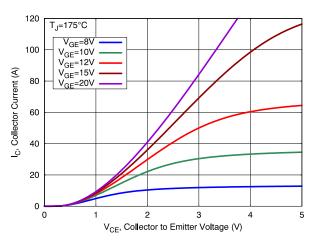


Figure 3. Output Characteristics

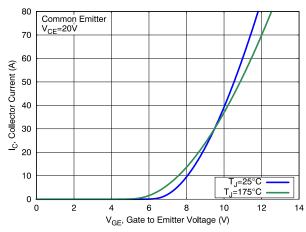


Figure 4. Transfer Characteristics

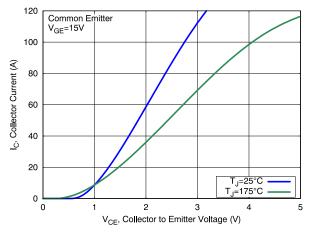


Figure 5. Saturation Characteristics

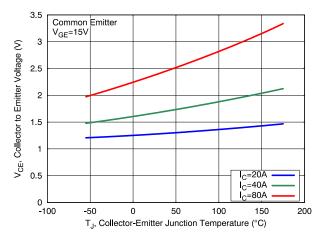


Figure 6. Saturation Voltage vs. Junction Temperature

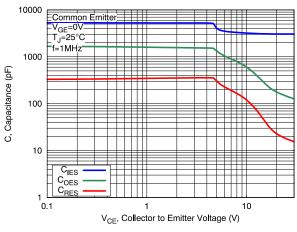


Figure 7. Capacitance Characteristics

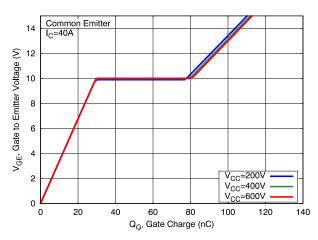


Figure 8. Gate Charge Characteristics

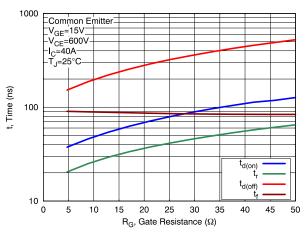


Figure 9. Switching Time vs Gate Resistance

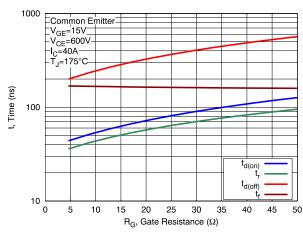


Figure 10. Switching Time vs Gate Resistance

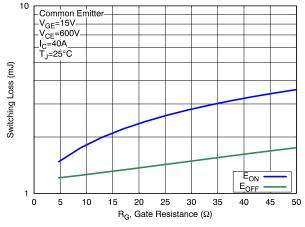


Figure 11. Switching Loss vs Gate Resistance

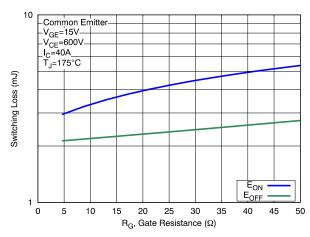


Figure 12. Switching Loss vs Gate Resistance

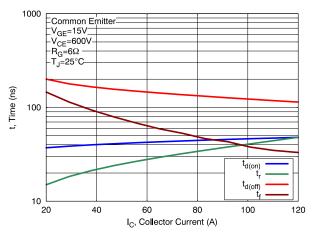


Figure 13. Switching Time vs Collector Current

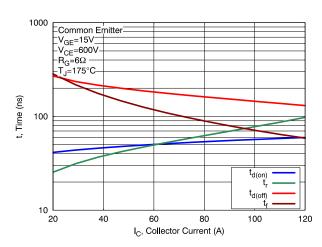


Figure 14. Switching Time vs Collector Current

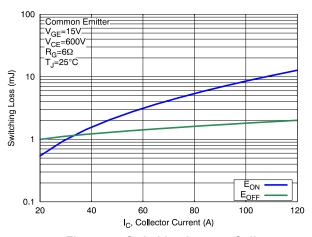


Figure 15. Switching Loss vs Collector Current

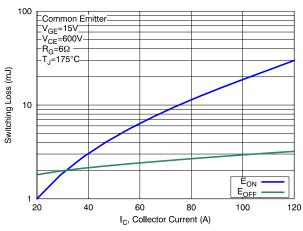


Figure 16. Switching Loss vs Collector Current

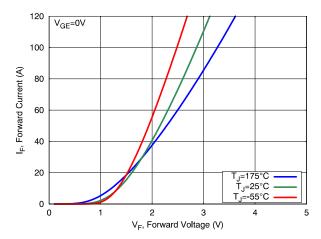


Figure 17. Diode Forward Characteristics

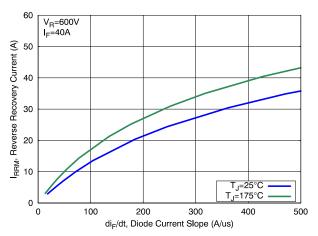


Figure 18. Diode Reverse Recovery Current

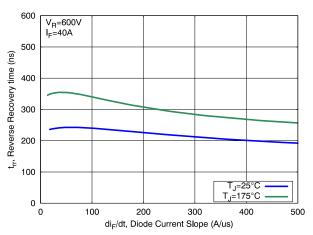


Figure 19. Diode Reverse Recovery Energy

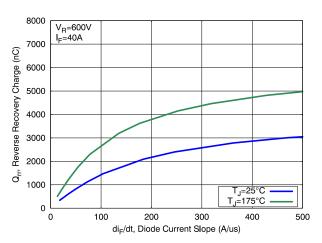


Figure 20. Diode Stored Charge Characteristics

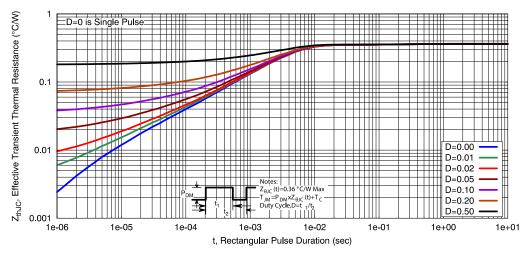


Figure 21. Transient Thermal Impedance of IGBT

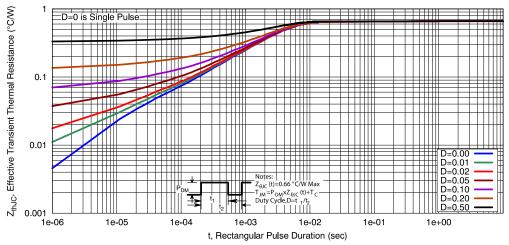


Figure 22. Transient Thermal Impedance of Diode

 \emptyset p1

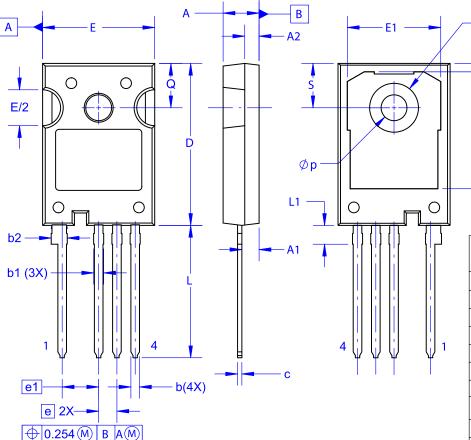
D1

D2



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019



NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
 B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
 FLASH, AND TIE BAR EXTRUSIONS.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.
 D. DRAWING CONFORMS TO ASME Y14.5-2009.

| DIM | MILLIMETERS | | | |
|-----|-------------|----------|-------|--|
| DIM | MIN NOM | | MAX | |
| Α | 4.80 | 5.00 | 5.20 | |
| A1 | 2.10 | 2.40 | 2.70 | |
| A2 | 1.80 | 2.00 | 2.20 | |
| b | 1.07 | 1.20 | 1.33 | |
| b1 | 1.20 | 1.40 | 1.60 | |
| b2 | 2.02 | 2.22 | 2.42 | |
| С | 0.50 | 0.60 | 0.70 | |
| D | 22.34 | 22.54 | 22.74 | |
| D1 | 16.00 | 16.25 | 16.50 | |
| D2 | 0.97 | 1.17 | 1.37 | |
| е | 2.54 BSC | | | |
| e1 | | 5.08 BSC | | |
| E | 15.40 | 15.60 | 15.80 | |
| E1 | 12.80 | 13.00 | 13.20 | |
| E/2 | 4.80 | 5.00 | 5.20 | |
| L | 18.22 | 18.42 | 18.62 | |
| L1 | 2.42 | 2.62 | 2.82 | |
| р | 3.40 | 3.60 | 3.80 | |
| p1 | 6.60 | 6.80 | 7.00 | |
| Q | 5.97 | 6.17 | 6.37 | |
| S | 5.97 | 6.17 | 6.37 | |

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|------------------|-------------|---|-------------|--|
| DESCRIPTION: | TO-247-4LD | | PAGE 1 OF 1 | |

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